



Report No.: R2211A1050

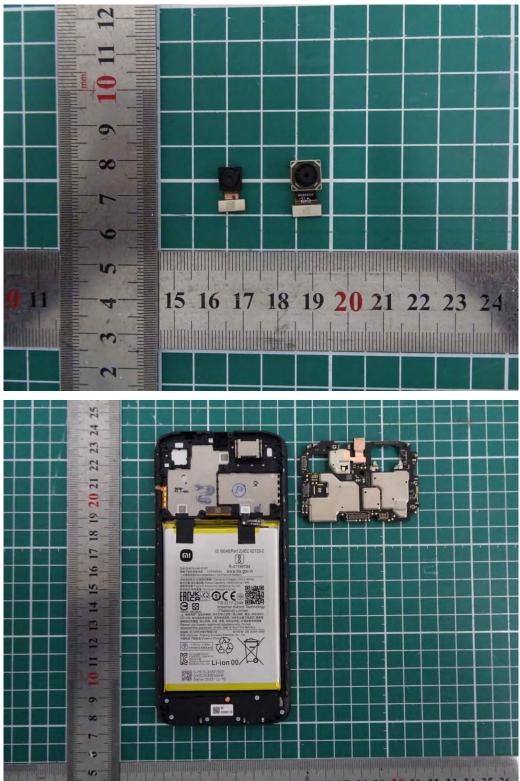




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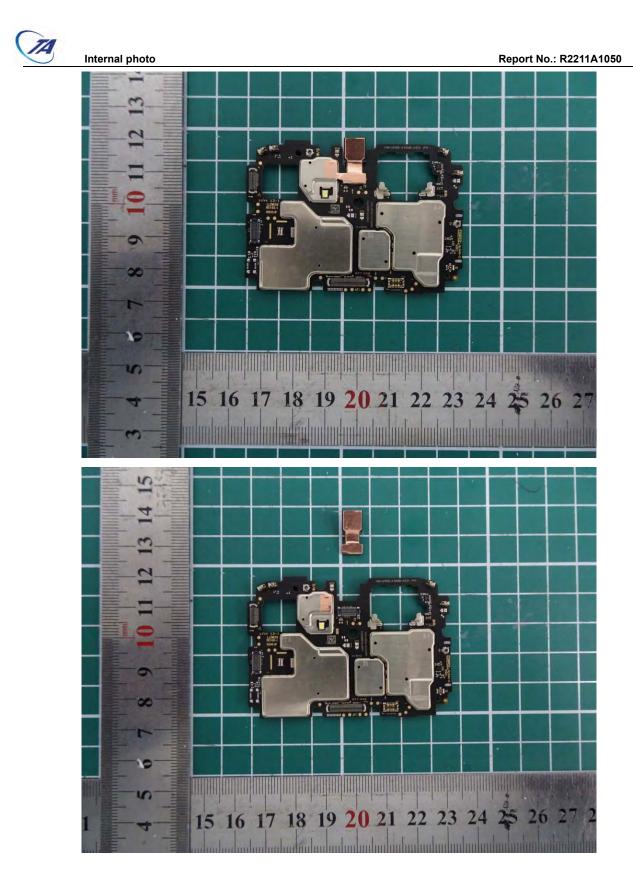




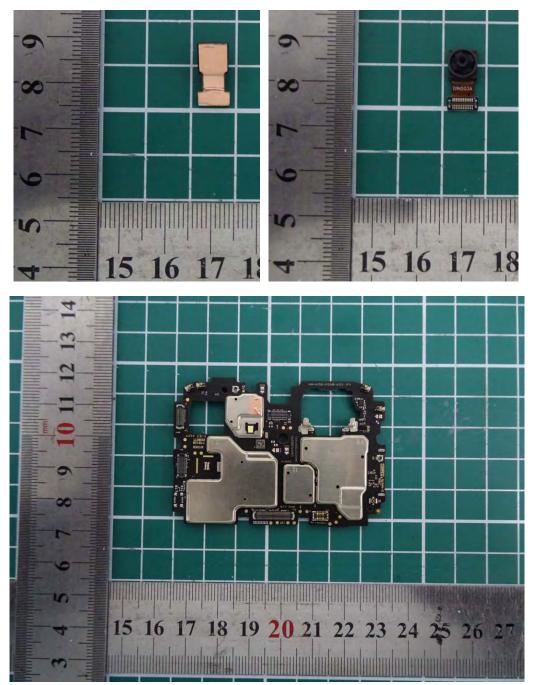






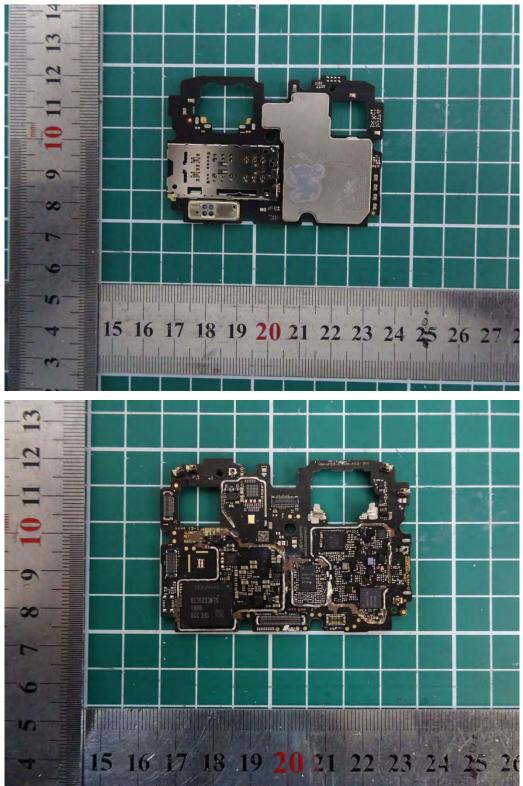




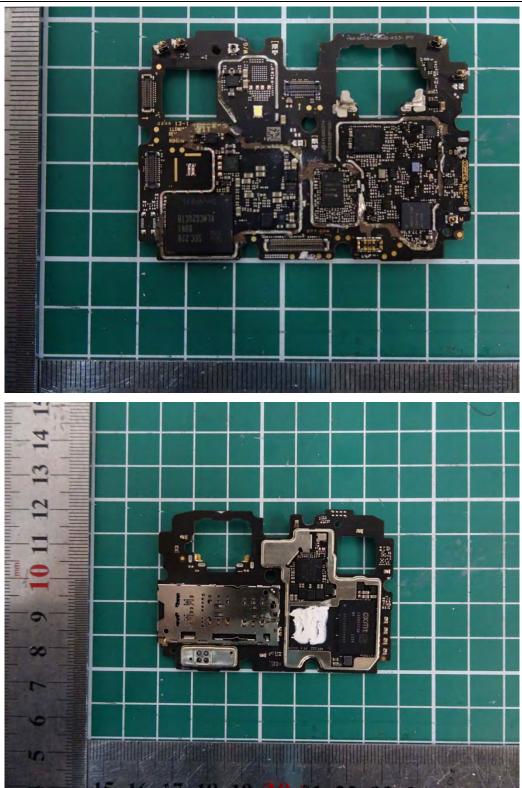




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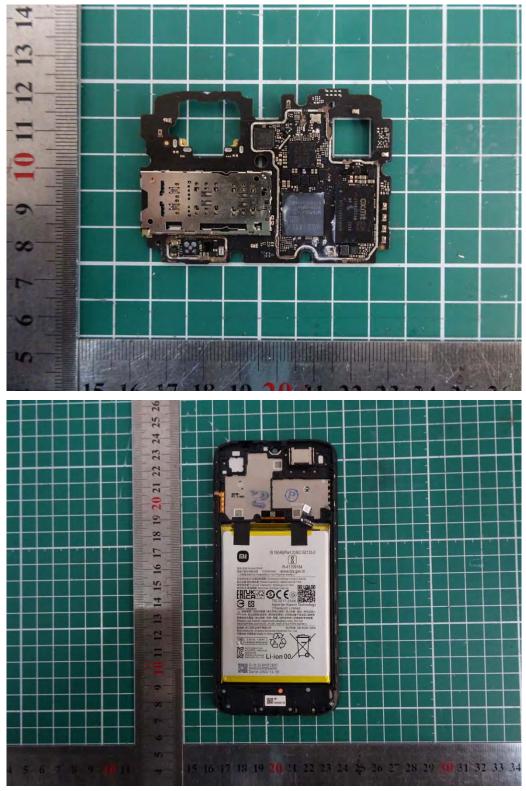








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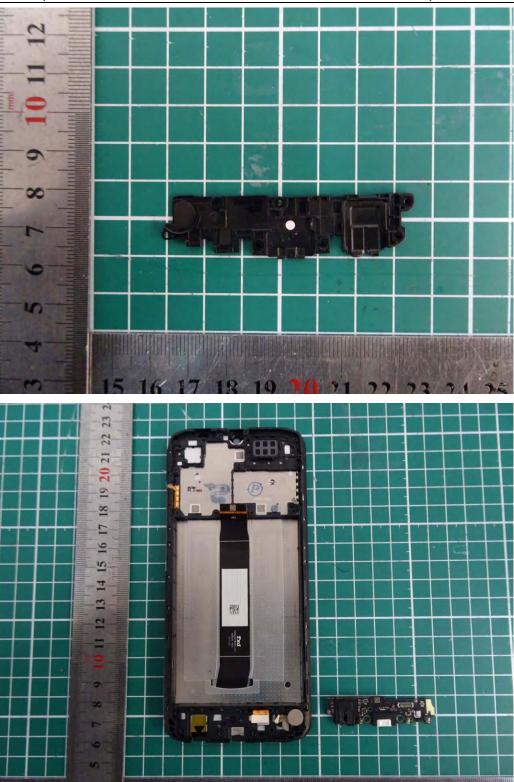






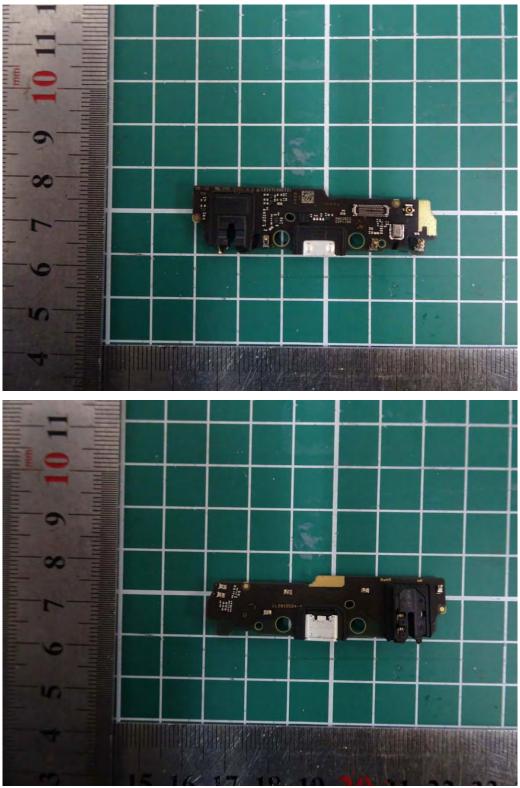




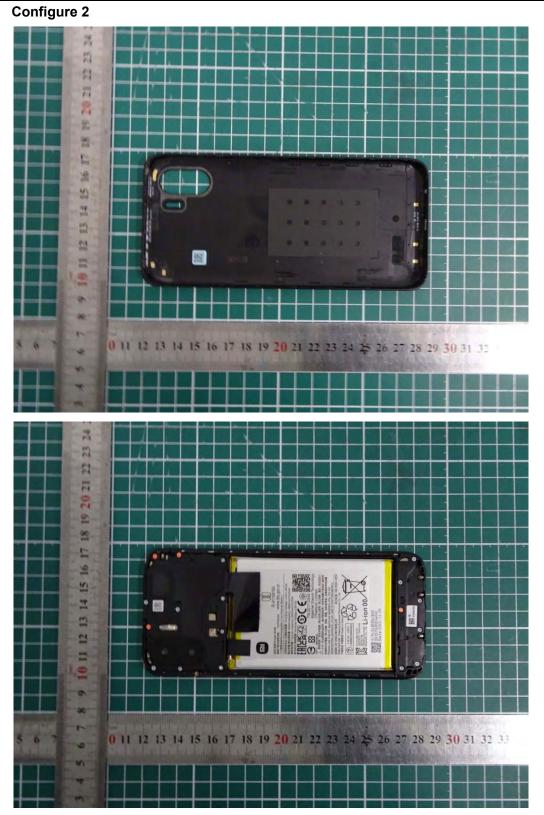




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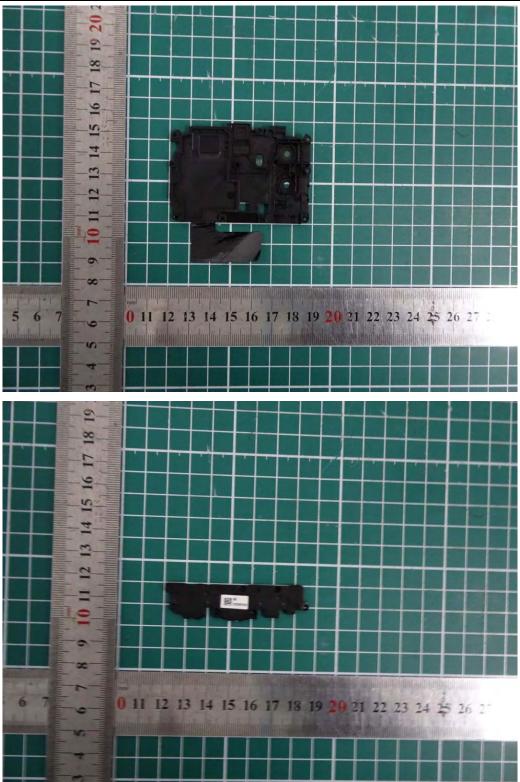


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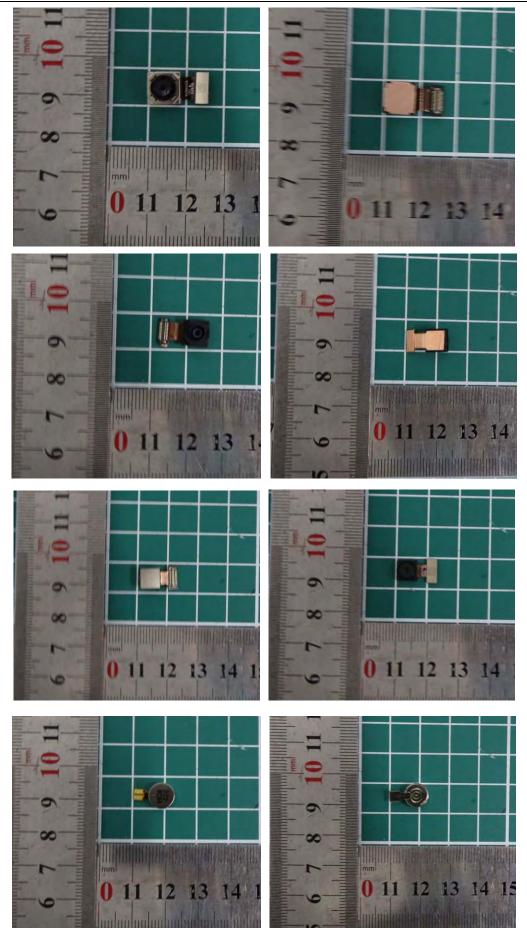




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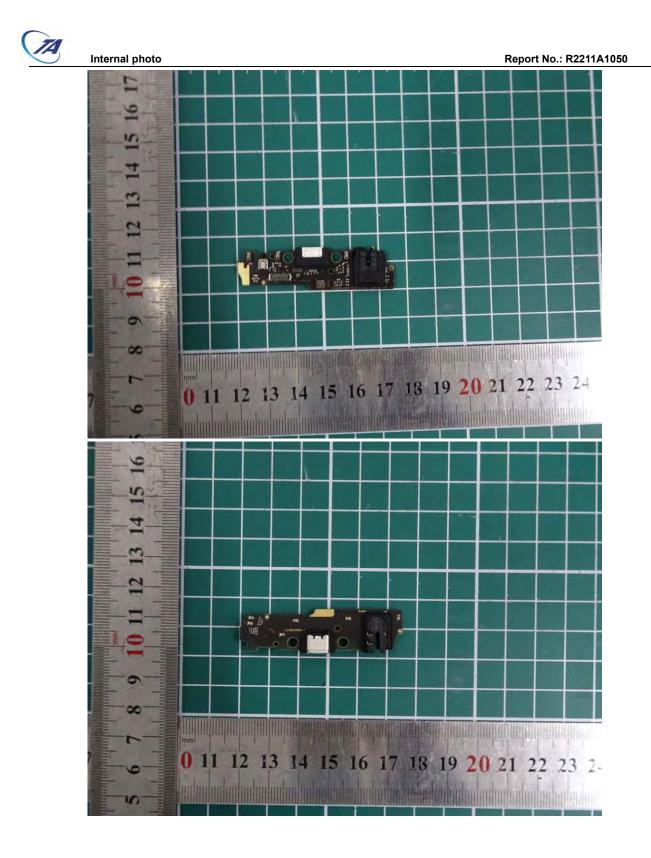






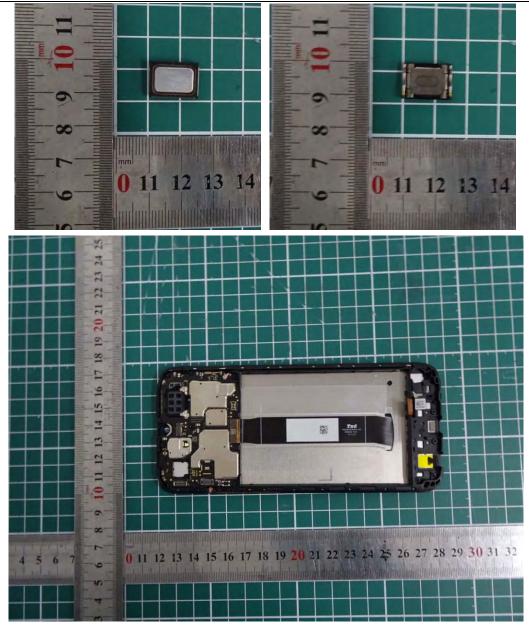
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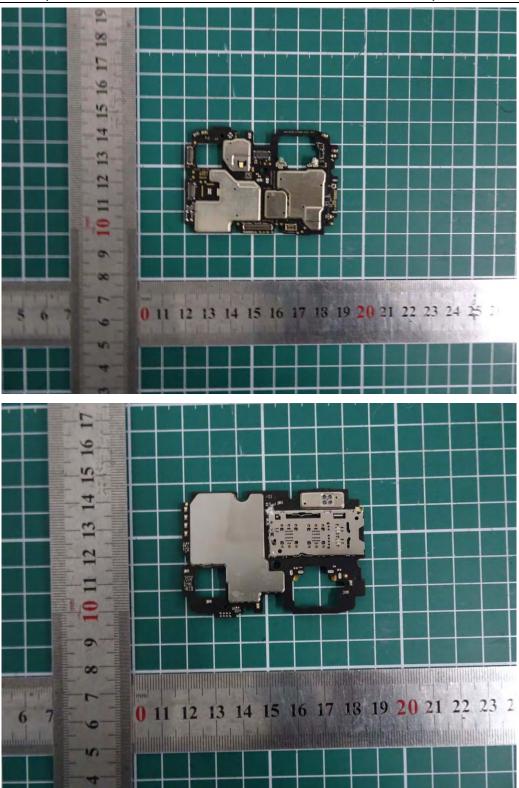




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